





Parameter	Rating	Units
Blocking Voltage	250	V _P
Load Current	0.7	A _{DC} /A _{rms}
On-Resistance	1.4	Ω

Features

- Power SIP Package
- Handle Load Currents Up to 0.7 A_{DC}/A_{rms}
- High Reliability
- No Moving Parts
- Low Drive Power Requirements (TTL/CMOS Compatible)
- · Arc-Free With No Snubbing Circuits
- 2500V_{rms} Input/Output Isolation
- No EMI/RFI Generation
- Machine Insertable, Wave Solderable

Applications

- Industrial Controls
- Motor Control
- Robotics
- Medical Equipment—Patient/Equipment Isolation
- Instrumentation
 - Multiplexers
 - Data Acquisition
 - Electronic Switching
 - I/O Subsystems
 - Meters (Watt-Hour, Water, Gas)
- IC Equipment
- · Home Appliances

Description

Clare and IXYS have combined to bring OptoMOS® technology, reliability, and compact size to a new family of high-power, solid state relays. As part of that family, the CPC1926 is a 1-Form-A solid state relay. The CPC1926 employs optically coupled MOSFET technology to provide 2500V_{rms} of input to output isolation. The efficient MOSFET switches and photovoltaic die use Clare's patented OptoMOS architecture while the output is controlled by a highly efficient GaAlAs infrared LED. The combination of low on-resistance and high load-current handling capabilities makes the relay suitable for a variety of high-performance switching applications.

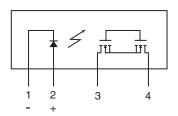
Approvals

- UL Recognized Component: File # E69938
- Certified to: UL 508

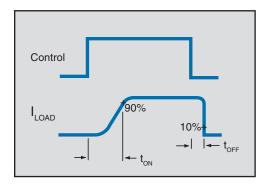
Ordering Information

Part #	Description	
CPC1926Y	Power SIP Package (25 per tube)	

Pin Configuration



Switching Characteristics of Normally Open (Form A) Devices











Absolute Maximum Ratings (@ 25° C)

Parameter	Ratings	Units
Blocking Voltage	250	V _P
Reverse Input Voltage	5	V
Input control Current	50	mA
Peak (10ms)	1	А
Input Power Dissipation 1	150	mW
Isolation voltage Input to Output	2500	V _{rms}
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

¹ Derate Linearly 3.33 mw / °C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Electrical Characteristics

Parameter	Conditions	Symbol	Min	Тур	Max	Units	
Output Characteristics @ 25°C							
Load Current, Continuous	Free air	IL	-	-	0.7	A_{DC}/A_{rms}	
Peak Load Current	t ≤ 10ms	I _{LPK}	-	-	3	A _P	
On-Resistance ¹	I _L =100mA	R _{ON}	-	1.2	1.4	Ω	
Off-State Leakage Current	V _L =250V	I _{LEAK}	-	-	1	μΑ	
Switching Speeds							
Turn-On	I _F =10mA, V _L =10V	t _{ON}	-	2.3	10	m.	
Turn-Off		t _{OFF}	-	0.022	10	ms	
Output Capacitance	50V, f=1MHz	C _{OUT}	-	60	-	pF	
Input Characteristics @ 25°C	Input Characteristics @ 25°C						
Input Control Current	I _L =120mA	I _F	-	3.75	10	mA	
Input Dropout Current	-	I _F	0.6	-	-	mA	
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V	
Reverse Input Current	V _R =5V	I _B	-	-	10	μΑ	
Input/Output Characteristics @ 25°C							
Capacitance Input/Output	f=1MHz	C _{I/O}	-	2	-	pF	

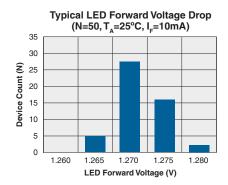
Measurement taken within 1 second of on time.

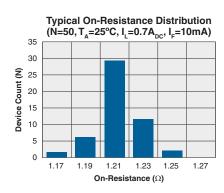
Thermal Characteristics

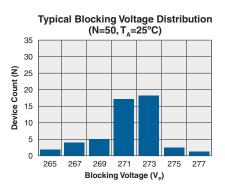
Parameter	Conditions	Symbol	Min	Тур	Max	Units
Thermal Resistance (junction to case)	-	R _{eJC}	-	1.5	-	°C/W

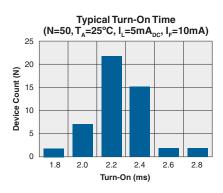


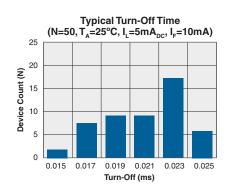
PERFORMANCE DATA*

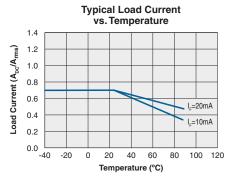


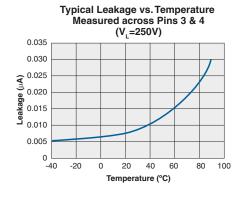


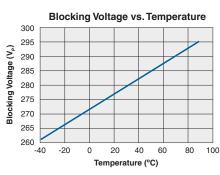


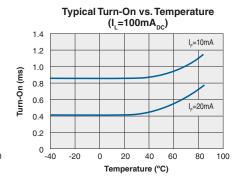


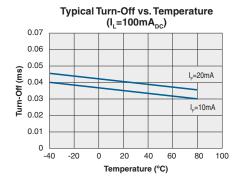


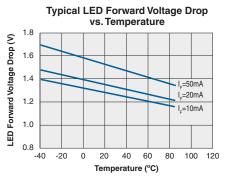


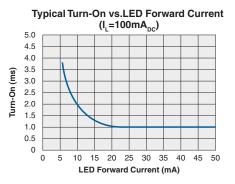








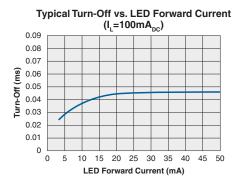


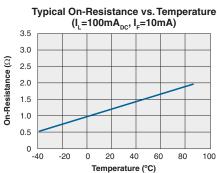


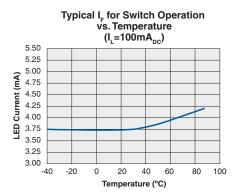
^{*}The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

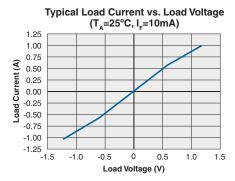


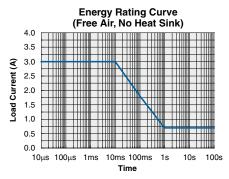
PERFORMANCE DATA*











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Manufacturing Information

Soldering

For proper assembly, the component must be processed in accordance with the current revision of IPC/JEDEC standard J-STD-020. Failure to follow the recommended guidelines may cause permanent damage to the device resulting in impaired performance and/or a reduced lifetime expectancy.

Washing

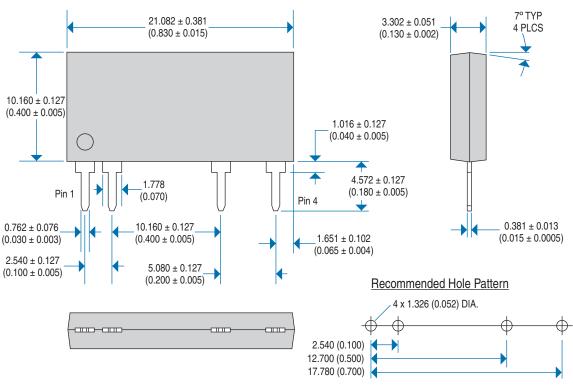
Clare does not recommend ultrasonic cleaning or the use of chlorinated solvents.







MECHANICAL DIMENSIONS



Dimensions mm (inches)

Note: Recommended hole size is based on the maximum cross-section diagonal measure of the pin plus 0.4mm (0.016).

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